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Designer's Data Sheet

Power Field Effect Transistor

P-Channel Enhancement-Mode Silicon Gate

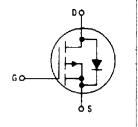
This TMOS Power FET is designed for medium voltage, high speed power switching applications such as switching regulators, converters, solenoid and relay drivers.

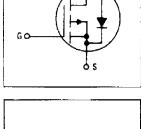
- Silicon Gate for Fast Switching Speeds Switching Times Specified at 100°C
- Designer's Data IDSS, VDS(on), VGS(th) and SOA Specified at Elevated Temperature
- Rugged SOA is Power Dissipation Limited
- Source-to-Drain Diode Characterized for Use With Inductive Loads

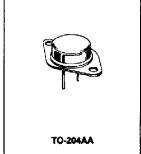


MTM20P10

TMOS POWER FET **20 AMPERES** $R_{DS(on)} = 0.15 OHM$ 100 VOLTS







MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|----------------------|------------|---------------|
| Drain-Source Voltage | VDSS | 100 | Vdc |
| Drain-Gate Voltage (R _{GS} = 1 MΩ) | VDGR | 100 | Vdc |
| Gate-Source Voltage Continuous Non-repetitive (t _p ≤ 50 <i>μ</i> s) | VGS VGSM | ±20 ±40 | Vdc Vpk |
| Drain Current Continuous Pulsed | I _D | 20 80 | Adc |
| Total Power Dissipation @ T _C = 25°C Derate above 25°C | PD | 125 1 | Watts W/°C |
| Operating and Storage Temperature Range | Tj, T _{stg} | -65 to 150 | °C |

THERMAL CHARACTERISTICS

| Thermal Resistance | | | °CW |
|--|--------------|---------|-----|
| Junction to Case Junction to Ambient | RAJC RAJA | 1 30 | |
| Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds | TL | 300 | °C |

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ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

| Characteristic | | Symbol | Min | Max | Unit |
|---|--|---------------------|-----------|-----------|------|
| OFF CHARACTERISTICS | 72-10-150V | | | | • |
| Drain-Source Breakdown Voltage (VGS = 0. ID = 0.25 mA) | | V(BR)DSS | 100 | _ | Vdc |
| Zero Gate Voltage Drain Current (VDS = Rated VDSS, VGS = 0) (VDS = Rated VDSS, VGS = 0, T | y = 125°C) | loss | _ | 10 100 | μAdc |
| Gate-Body Leakage Current, Forward (VGSF = 20 Vdc, VDS = 0) | d | IGSSF | _ | 100 | nAdc |
| Gate-Body Leakage Current, Reverse (VGSR = 20 Vdc, VDS = 0) | 3 | ^I G\$SR | _ | 100 | nAdc |
| ON CHARACTERISTICS* | | | • | | |
| Gate Threshold Voltage (VDS = VGS, ID = 1 mA) T _J = 100°C | | VGS(th) | 2 1.5 | 4.5 4 | Vdc |
| Static Drain-Source On-Resistance (VGS = 10 Vdc, ID = 10 Adc) | | R _{DS(on)} | _ | 0.15 | Ohm |
| Drain-Source On-Voltage (VGS = 10 (ID = 20 Adc) (ID = 10 Adc, TJ = 100°C) |) V) | VDS(on) | _ | 3.2 3 | Vdc |
| Forward Transconductance (V _{DS} = 10 V, I _D = 10 A) | | 9FS | 5 | _ | mhos |
| DYNAMIC CHARACTERISTICS | | | | | |
| Input Capacitance | (VDS = 25 V, VGS = 0, | Ciss | _ | 2000 | pF |
| Output Capacitance | f = 1 MHz) | Coss | _ | 950 | |
| Reverse Transfer Capacitance | See Figure 10 | Crss | _ | 400 | |
| SWITCHING CHARACTERISTICS* (T | J = 100°C) | | | | |
| Turn-On Delay Time | | td(on) | | 45 | ns |
| Rise Time | (V _{DD} = 25 V, I _D = 0.5 Rated I _D | t _r | _ | 200 | - |
| Turn-Off Delay Time | R _{gen} = 50 ohms) See Figures 12 and 13 | td(off) | _ | 150 | |
| Fall Time | | tę | | 150 | |
| Total Gate Charge | (Vps = 0.8 Rated Vpss, | Ωg | 52 (Typ) | 75 | nC |
| Gate-Source Charge | ID = Rated ID, VGS = 10 V) See Figure 11 | o _{gs} | 22 (Typ) | | |
| Gate-Drain Charge | | Q _{gd} | 30 (Typ) | | |
| SOURCE DRAIN DIODE CHARACTE | RISTICS* | | | | |
| Forward On-Voltage | (is = Rated ip VGS = 0) | VSD | 2.8 (Typ) | 4 | Vdc |
| Forward Turn-On Time | | ton | 100 (Typ) | | ns |
| Reverse Recovery Time | | trr | 350 (Typ) | _ | ns |

^{*}Pulse Test: Pulse Width ≤ 300 µs, Duty Cycle ≤ 2 0%.